

METAL SINGLE-IN-LINE MODULE

Suffix N

0.48 (12,19) MAX.

0.310 (7,87)

0.90 (22,86) MAX.

0.95 (24,13) MAX.

0.032 (0,81) TYP.

0.040 (1,01) TYP.

0.025 (0,63) TYP.

0.017 (0,43) TYP.

0.100 (2,54) TYP.

0.160 (4,06) TYP.

Note G

0.140 (3,55) MIN.
See Note F

0.94 (23,87)

0.860 (21,84)

0.040 (1,01)

0.51 (12,95)

0.330 (8,38)

0.100 (2,54)
2 Places

0.35 (8,89)

0.200 (5,08)

0.080 (2,03)
2 Places

0.080 (2,03)

ø0.065 (1,65) MIN. 4 Places
Plated through connected
to ground plane

Note E

ø0.045 (1,14) MIN. 3 Places
Plated through

PC LAYOUT (TOP VIEW)

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